

## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	Fluid Conduit and Process Therefor	
Application Type:	regular, utility	
Attorney Docket Number:	CH2893	
Correspondence address:		
Customer Number:	23906	*23906*
Priority Data:		
Doc.No: JP 2002-337779; Country - JP; Date: 2002-11-21 us-priority-claimed		
Inventors Information:		
<u>Inventor 1:</u>		
Applicant Authority Type:	Inventor	
Citizenship:	JP	
Given Name:	Yukiyoshi	
Family Name:	Sunada	
City of Residence:	Tokyo	
Country of Residence:	JP	
Address-1 of Mailing Address:	7-20-1-402 Arakawa	
Address-2 of Mailing Address:	Arakawa-ku	
City of Mailing Address:	Tokyo	
State of Mailing Address:		
Postal Code of Mailing Address:	116-0002	
Country of Mailing Address:	JP	
Phone:		

Fax:

E-mail:

Inventor 2:

Applicant Authority Type: Inventor  
Citizenship: JP  
Given Name: Konosuke  
Family Name: Kedamori  
City of Residence: Saitama  
Country of Residence: JP  
Address-1 of Mailing Address: 596-202 Sendano  
Address-2 of Mailing Address: Shiraoka-machi, Minamisaitama-gun  
City of Mailing Address: Saitama  
State of Mailing Address:  
Postal Code of Mailing Address: 349-0215  
Country of Mailing Address: JP  
Phone:  
Fax:  
E-mail:

Inventor 3:

Applicant Authority Type: Inventor  
Citizenship: JP  
Given Name: Satoko  
Family Name: Iwato  
City of Residence: Tokyo  
Country of Residence: JP  
Address-1 of Mailing Address: 4-27-8 Jingumae  
Address-2 of Mailing Address: Shibuya-ku  
City of Mailing Address: Tokyo  
State of Mailing Address:

Postal Code of Mailing Address: 150-0001

Country of Mailing Address: JP

Phone:

Fax:

E-mail:

**Inventor 4:**

Applicant Authority Type: Inventor

Citizenship: JP

Given Name: Hozue

Family Name: Tatsuno

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Country of Residence: JP

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City of Mailing Address: Tokyo

State of Mailing Address:

Postal Code of Mailing Address: 153-0064

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